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- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

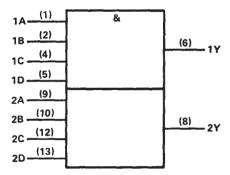
These devices contain two independent 4-input AND gates.

The SN54LS21 is characterized for operation over the full military temperature range of -55 °C to 125 °C. The SN74LS21 is characterized for operation from 0 °C to 70 °C.

FUNCTION	TABLE	(each	gate)
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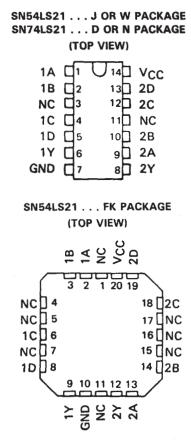
	INP	UTS	OUTPUT	
A	в	С	D	Y
н	н	н	н	н
L	х	х	x	L
X	L	х	X	L
X	х	L	x	L
X	х	х	L	L

logic symbol[†]



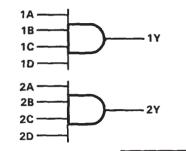
[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.



NC-No internal connection

logic diagram



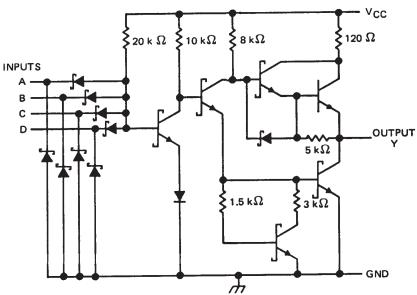
(positive logic) Y = A•B•C•D or Y = $\overline{\overline{A} + \overline{B} + \overline{C} + \overline{D}}$

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

SN54LS21, SN74LS21 DUAL 4-INPUT POSITIVE-AND GATES

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schematics (each gate)



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)	
Operating free-air temperature range: SN54'	-55°C to 125°C
SN74' Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminals.



SN54LS21, SN74LS21 DUAL 4-INPUT POSITIVE-AND GATES

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recommended operating conditions

		SN54LS21			SN74LS21		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	v
VIH High-level input voltage	2			2			V
VIL Low-level input voltage			0.7			0.8	V
OH High-level output current			- 0.4			- 0.4	mA
IOL Low-level output current			4			8	mA
T _A Operating free-air temperature	- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS T			SN54LS21			SN74LS21			
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
VIK	V _{CC} = MIN,	l _l = – 18 mA				- 1.5			1.5	V
VOH	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OH} ≂ – 0.4 mA	2.5	3.4		2.7	3.4		v
	V _{CC} = MIN,	VIL = MAX,	I _{OL} = 4 mA		0.25	0.4		0.25	0.4	v
VOL	V _{CC} = MIN,	VIL = MAX,	I _{OL} = 8 mA					0.35	0.5	
1	V _{CC} = MAX,	V _I = 7 V				0.1			0.1	mA
Чн	V _{CC} = MAX,	V _I = 2.7 V				20			20	μA
	V _{CC} = MAX,	V _I = 0.4 V				- 0.4			- 0.4	mA
los§	V _{CC} = MAX			- 20		- 100	- 20		- 100	mA
Іссн	V _{CC} = MAX,	V ₁ = 4.5 V			1.2	2.4		1.2	2.4	mA
ICCL	V _{CC} = MAX,	V _I = 0 V			2.2	4.4		2.2	4.4	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 \ddagger All typical values are at V_{CC} = 5 V, T_A = 25^oC § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS			TYP	MAX	UNIT
^t PLH		×	R L = 2 kΩ,	C _L = 15 pF		8	15	ns
tPHL	Алу	Ť				10	20	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



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